



Pulp and Paper Industry Committee James A. Roops Memorial Young Engineering Professionals Program

One of the challenges the Pulp and Paper Industry faces going forward is attracting and retaining new, young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industrial Applications Society (IAS) to provide a limited number of partial financial sponsorships for young engineers to attend to their upcoming Annual Conference.

What is included?

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| ✓ Travel and Lodging Expenses up to \$1,000 | ✓ Conference Reception |
| ✓ Conference Registration | ✓ Conference Social Event |
| ✓ One Tutorial | ✓ Meals |
| ✓ Vendor Exhibition | ✓ IEEE and IAS Membership |

What are the requirements?

- Full time employee of a Pulp and Paper Products Industry end-user (Pulp, Paper, Board, Tissue, etc.) or consulting engineer working in support of clients in the industry.
- Less than 5 years of experience in the Industry.
- First Time IEEE PPIC Conference attendee.
- Able to participate in the entirety of the conference.
- IEEE/IAS will reimburse either the employee or company for the documented travel costs of airfare, other transportation and meals up to a maximum of \$1,000 per young engineering professional.
- Conference Registration and IEEE Membership will be refunded after you attend the Conference. If you are unable to attend after registering, normal cancellation policy will be in effect.
- Open to North American applicants only.

A few highlights from the Conference:

- Welcome Reception at the hotel on Sunday evening.
- Technical paper presentations, vendor exhibitions, and panel discussions over the course of 3 days.
- Conference Closing event, including dinner and the Technical Paper Awards.
- PPIC Subcommittee meetings are held, which is where the ideas for future papers are presented.

The PPIC Subcommittees are:

- DCS – Drives and Control Systems
- PCEMC – Process Control, Engineering, Maintenance and Construction
- PDS – Power Distribution Systems
- S&T – Safety and Training
- Standards – Development of IEEE Standards as related to the Pulp and Paper Industry

Visit www.pulppaper.org for more information on the Conference!



Young Engineering Professional Program Application

NAME	
PREFERRED FIRST NAME <i>(if different)</i> & PRONOUNS	
TITLE <i>(ie. Electrical Engineer, Reliability Engineer, etc.)</i>	
IEEE MEMBER NUMBER <i>(if already a member)</i>	
ACTIVE EMAIL ADDRESS	
PHONE NUMBER	
COMPANY	
COMPANY LOCATION <i>(Mailing Address)</i>	
COLLEGE NAME	
DEGREE & GRADUATION DATE	
SUBCOMMITTEE PREFERENCE	
TUTORIAL PREFERENCE	
DIETARY RESTRICTIONS	

If you are not currently a member of IEEE and the IAS, you will be required to join IEEE and the IAS as a professional member before attending the conference. First year membership fees will be reimbursed after the conference.

Final selection of the successful applicants will be based on the qualifications listed above, the order that the applications were received, and how many applicants there are from different companies. Successful applicants will be notified as quickly as possible.

Please return this application by **MAY 10** via e-mail, and direct any questions to:

Emily Held
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217-827-4099